# BergStak® Lite 0.80mm Board-to-Board Connector

Extraordinary product range, Benchmark performance, Dual-source champion

## **ECONOMICAL OPTION FOR HIGH DENSITY APPLICATIONS**

Amphenol's BergStak® Lite 0.8mm is a flexible solution designed for high speed and high density, parallel board-toboard connector system with 16 PCB stack heights in 4 sizes up to 100 positions.

- Housing and terminal profile guarantees support of up to
- 40 to 100 position sizes in 20 position increments
- 5mm to 20mm stack heights in 1mm increments
- Gold flash plating on contact area supports 50 mating cycles for lower mating cycle application



#### **FEATURES**

- Housing and terminal profile guarantees support of up to
- 40 to 100 position sizes in 20 position increments
- 5mm to 20mm stack heights in 1mm increments
- 0.80mm double-row contact pitch conserves printed circuit board space
- Scoop-proof housings
- Gold flash contact plating
- PCB locator pegs option
- Available in UL94V-0 flammability rated LCP
- RoHS compliant and lead-free

#### **BENEFITS**

- Compatible with PCIe Gen 2/3 and SAS 3.0 high speed performance on selected stack heights
- Comprehensive range of sizes and stack heights to satisfy all needs
- High density for all electrical applications needs
- Ensures terminals are not damaged during mating
- Economical option for applications that require less stringent requirements
- Facilitates ease and accuracy during manual assembly
- High flammability rating
- Meets environmental, health and safety requirements

<sup>\*</sup>The PCIe® mark is a registered trademark of the PCI-SIG Corp

### **▶** BergStak® Lite 0.80mm Board-to-Board Connector

### TECHNICAL INFORMATION

#### **MATERIAL**

Housing: Glass filled LCP, UL94V-0

• Contact Base Metal

■ Receptacle: Copper Alloy

■ Plug: Copper Alloy

• Contact Area Finish: Gold flash over Nickel

Solder Area Finish: Matte pure Tin over Nickel

#### **MECHANICAL PERFORMANCE**

Durability: 50 mating cycles

Mating Force: 0.9N max./contact

Unmating Force: 0.1N min./contact

#### **ELECTRICAL PERFORMANCE**

• Insulation Resistance:

• Initial:  $1000M\Omega$  min.

• After Test:  $100M\Omega$  min.

Current Rating: 0.5A/contact

• Contact Resistance:

• Initial:  $40m\Omega$  max.

• After Test:  $60m\Omega$  max.

Voltage Rating: 100VAC

• Signal Integrity (Differential pairs, connector and SMT pads only)

• Impedance Range: 81 to  $108\Omega$  @ 50 ps edge

(10-90%)

• Return Loss: < 10dB up to 5GHz

■ Insertion Loss: < 1.5dB up to 5GHz

■ NEXT: ≤ 4.0% for a 50 ps edge (10-90%)

FEXT: ≤ 2.4% for a 50 ps edge (10-90%)

#### **ENVIRONMENTAL**

■ Temperature Range: -40°C to +125°C

■ High Temperature Life: 125°C ± 5°C for 96 hours

■ Humidity: 90-95% relative humidity for 96 hours

• Mixed Flowing Gas Class 2a: 5 days mated

#### **APPROVALS AND CERTIFICATIONS**

■ UL E66906

■ File no. LR46923

#### **SPECIFICATIONS**

■ Product Specification: GS-12-1424

#### **PACKAGING**

■ Tape & Reel

#### **TARGET MARKETS/APPLICATIONS**



**IP Phones** 



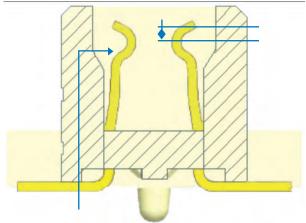
Drone



Measurement Equipment Point-of-Sales (POS) Terminal Portable Industrial Terminal Security Systems Test Equipment

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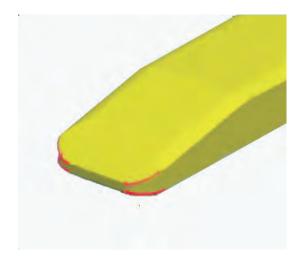
## **RECEPTACLE**



Early-contact point allows early engagement/ late disengagement and increases mating wipe

Precision-tapered contacts control mating stress while providing reliable, high normal force

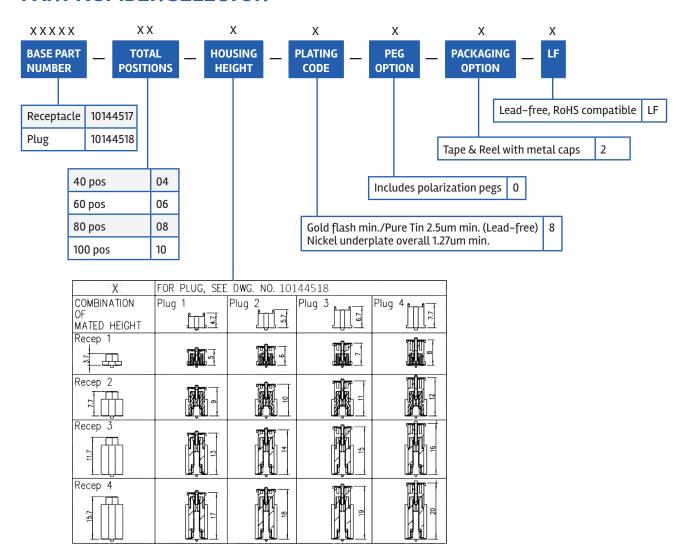
## **HEADER**



Coined contact tips assure smooth, safe wiping action during connector mating

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### **PART NUMBER SELECTOR**



## 单击下面可查看定价,库存,交付和生命周期等信息

>>Amphenol(安费诺)